onsemi

<u>MOSFET</u> – Power, Single N-Channel 60 V, 1.2 mΩ, 287 A

NV	MFS5	C604	NL
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Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C604NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	287	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		203	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	200	W
R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	1	100	1
Continuous Drain	Steady State	T _A = 25°C	I _D	40	А
Current R _{θJA} (Notes 1, 2, 3)		$T_A = 100^{\circ}C$		28	1
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.9	W
R _{θJA} (Notes 1 & 2)		$T_A = 100^{\circ}C$	1	1.9	1
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	203	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 22 A)			E _{AS}	776	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

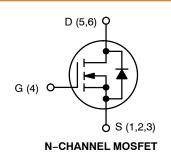
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	R _{θJA}	39	

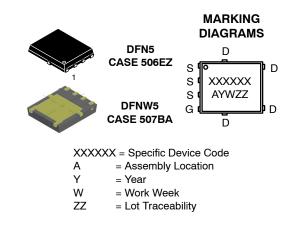
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 $\rm mm^2,$ 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.2 m Ω @ 10 V	007 4
60 V	$1.7~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	287 A





ORDERING INFORMATION

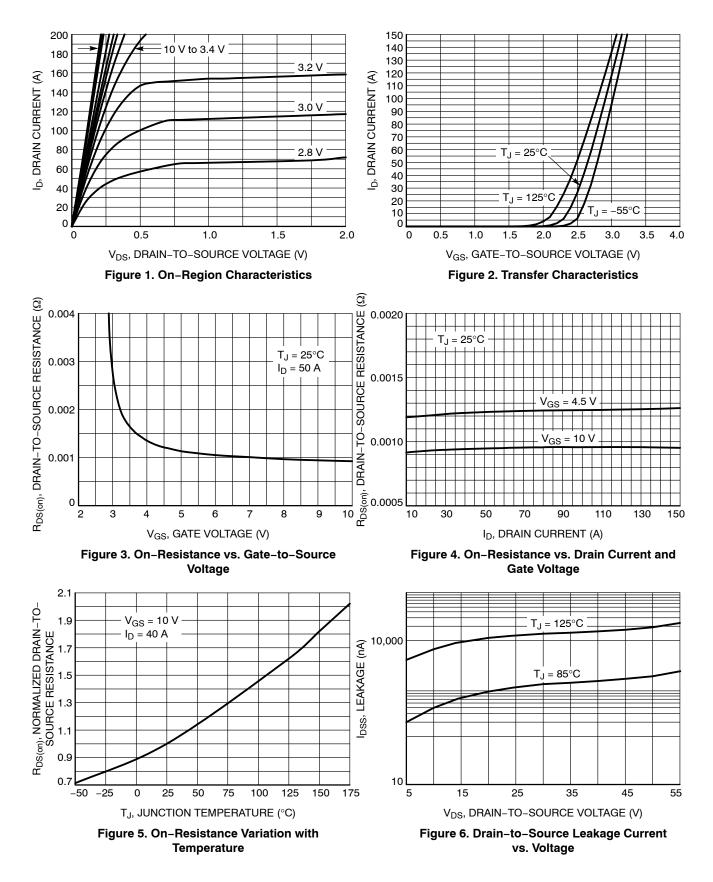
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

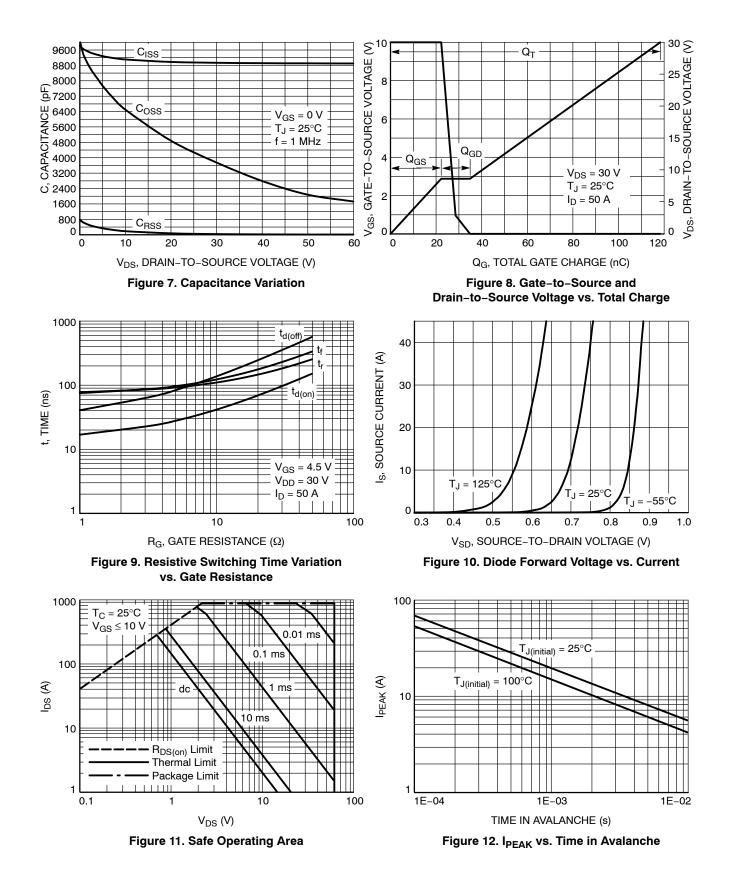
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				22.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$				10	
		V _{DS} = 60 V	$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±16 V				±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.93	1.2	mΩ
		V _{GS} = 4.5 V	I _D = 50 A		1.25	1.7	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _[₀ = 50 A		180		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			8900		
Output Capacitance	C _{OSS}				3750		pF
Reverse Transfer Capacitance	C _{RSS}				40		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 3	30 V; I _D = 50 A		52		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 30 V; I _D = 50 A			120		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			6.4		nC
Gate-to-Source Charge	Q _{GS}				21.4		
Gate-to-Drain Charge	Q _{GD}				12.7		
Plateau Voltage	V _{GP}				2.8		V
SWITCHING CHARACTERISTICS (Note §	5)						
Turn–On Delay Time	t _{d(ON)}				21.8		
Rise Time	t _r	Vcs = 4.5 V. Vr	os = 30 V.		79.1		1
Turn–Off Delay Time	t _{d(OFF)}	$\begin{array}{l} V_{\mathrm{GS}}=\text{4.5 V}, V_{\mathrm{DS}}=\text{30 V},\\ I_{\mathrm{D}}=\text{50 A}, R_{\mathrm{G}}=\text{2.5 }\Omega \end{array}$			57.8		ns
Fall Time	t _f				81.3		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	T _J = 25°C		0.78	1.2	
			T _J = 125°C		0.64		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			98		
Charge Time	ta				45		ns
Discharge Time	t _b				53		
Reverse Recovery Charge	Q _{RR}				190		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



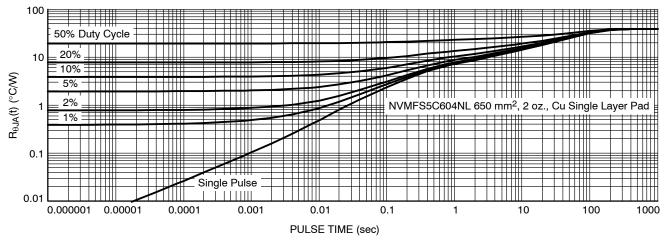


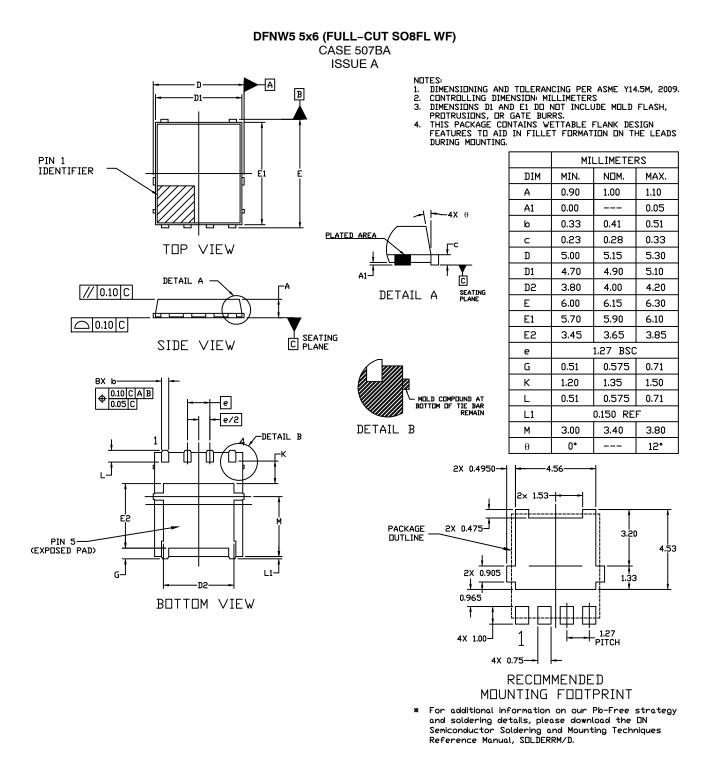
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

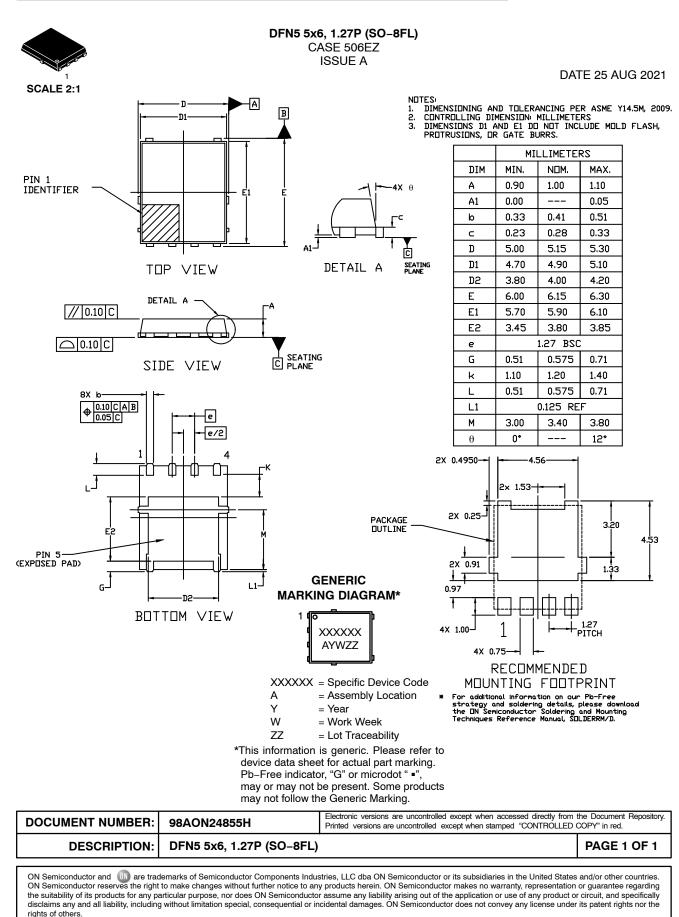
Device	Case	Marking	Package	Shipping [†]
NVMFS5C604NLT1G	506EZ	5C604L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C604NLWFT1G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C604NLT3G	506EZ	5C604L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C604NLWFT3G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C604NLAFT1G	506EZ	5C604L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C604NLWFAFT1G	507BA	604LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS







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